

## PROCESS ENGINEER

Opened: 2/14/14 Job Req. # 0473

Department: Manufacturing Engineering

Status: Full-Time / Exempt

## **Job Responsibilities:**

The process engineer will support production, sustain production processes, develop new processes and implement process improvements in the backside processing areas, including wafer bonding, thinning, polishing, as well as backside via etch, metallization, wafer demount and cleaning. The candidate must have a good understanding of III-V compound semiconductor device and process technologies.

## **Job Requirments:**

Must have a Bachelor's or Master's degree in science or engineering with at least 3-5 years of work experience in related field. Hands-on experience in semiconductor processing equipment and metrology tools. Familiarity with compound semiconductor processing is desirable. Excellent written and communication skills. Experience with statistical process control and design of experiments. Process failure verbal analyses is a plus.